

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hongsik Kim</td> <td>11/05/2012</td> </tr> <tr> <td>Donghwan Lee</td> <td>11/05/2012</td> </tr> <tr> <td>Seihyun Cho</td> <td>11/05/2012</td> </tr> </tbody> </table>		Name	Execution Date	Hongsik Kim	11/05/2012	Donghwan Lee	11/05/2012	Seihyun Cho	11/05/2012
Name	Execution Date								
Hongsik Kim	11/05/2012								
Donghwan Lee	11/05/2012								
Seihyun Cho	11/05/2012								
RECEIVING PARTY DATA									
Name:	LG Electronics Inc.								
Street Address:	20 Yeouido-dong Yeongdeungpo-gu								
City:	Seoul								
State/Country:	KOREA, REPUBLIC OF								
Postal Code:	150-721								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>29436446</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	29436446				
Property Type	Number								
Application Number:	29436446								
CORRESPONDENCE DATA									
Fax Number:	2027393001								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone:	2027393000								
Email:	adowney@morganlewis.com, patents@morganlewis.com								
Correspondent Name:	Robert J. Goodell								
Address Line 1:	1111 Pennsylvania Avenue NW								
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20004								
ATTORNEY DOCKET NUMBER:	001082-7112								
NAME OF SUBMITTER:	Robert J. Goodell								
Total Attachments: 2 source=001082-7012_Assignment-11062012#page1.tif source=001082-7012_Assignment-11062012#page2.tif									

CH \$40.00 29436446

PATENT

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

MOBILE PHONE

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

WHEREAS, LG ELECTRONICS INC., a corporation of Republic of Korea, whose post office address is 20 Yeouido-dong Yeongdeungpo-gu Seoul 150-721 Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. 29/436,446....., filed 6 November 2012) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Hongsik KIM	Assignor's Signature Hongsik Kim	Date November 5, 2012
Address Sungwon Apt. 116-1102, Sanghyeon-2-dong, Suji-gu, Yongin-si, Gyeonggi-do, Korea		Citizenship Republic of Korea
Full Name of Second Assignor Donghwan LEE	Assignor's Signature Donghwan Lee	Date November 5, 2012
Address SarunMaeul LIG Kunyoung Liga Apt. 403-103, Pangyo-dong 899, Bundang-gu, Seongnam-si, Gyeonggi-do, Korea		Citizenship Republic of Korea
Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		

Full Name of Third Assignor Seihyun CHO	Assignor's Signature <i>Seihyun Cho</i>	Date November 5, 2012
Address Mugigae Maoul Jeil Apt. 801-1202, Gumi-dong 243, Bundang-gu, Seongnam-si, Gyeonggi-do, Korea		Citizenship Republic of Korea
Full Name of Fourth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Fifth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Sixth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Seventh Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eighth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Ninth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Tenth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		